

N-Channel 60V, 1.7Ω Typ. Power MOSFET

### Description

### **Features**

• 60V, 0.3A

 $R_{DS(ON)}$  Typ = 1.7 $\Omega$  @ V<sub>GS</sub> = 10V

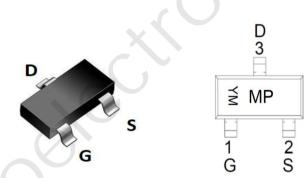
 $R_{DS(ON)}$  Typ = 2  $\Omega$  @ V<sub>GS</sub> = 4.5V

- Advanced Trench Technology
- Excellent R<sub>DS(ON)</sub> and Low Gate Charge
- Lead Free
- ESD Protected: 2KV

# Application

- Load Switch
- PWM Application
- Power Management

# Schematic Diagram



Marking and Pin Assignment

# Package Marking and Ordering Information

Device	Marking	Package	Outline	Reel Size	Reel (pcs)	Per Carton (pcs)
CRMLCTL2N7002K	MP	SOT-523-3L	TAPING	7"	3000	120000

### Absolute Maximum Ratings (@ T<sub>J</sub> = 25°C unless otherwise specified)

Symbol	Parameter		Value	Units
V <sub>DS</sub>	Drain-to-Source Voltage		60	V
V <sub>GS</sub>	Gate-to-Source Voltage		±20	V
	Continuous Drain Current	T <sub>A</sub> = 25°C	0.3	А
ID	Continuous Drain Current	T <sub>A</sub> = 100°C	0.18	А
I <sub>DM</sub>	Pulsed Drain Current <sup>(1)</sup>		1.2	А
P <sub>D</sub>	Power Dissipation	T <sub>A</sub> = 25°C	0.17	W
$R_{ ext{ ext{ ext{ ext{ ext{ ext{ ext{ ext$	Thermal Resistance, Junction to	Ambient <sup>(2)</sup>	735	°C/W
T <sub>J</sub> , T <sub>STG</sub>	Junction & Storage Temperature	Range	-55 to 150	°C



#### **Electrical Characteristics** (T<sub>J</sub> = 25°C unless otherwise specified)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Off Chara	acteristics					
V <sub>(BR)DSS</sub>	Drain-Source Breakdown Voltage	I <sub>D</sub> = 250μA, V <sub>GS</sub> = 0V	60	-	-	V
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> = 60V, V <sub>GS</sub> = 0V	-	-	1.0	μA
I <sub>GSS</sub>	Gate-Body Leakage Current	$V_{DS} = 0V, V_{GS} = \pm 20V$	-	-	±10	μA
On Chara	acteristics				6	
V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{DS}$ = $V_{GS}$ , $I_D$ = 250 $\mu$ A	1	1.6	2	V
Р		$V_{GS}$ = 10V, $I_{D}$ = 0.3A	-	1.7	2.1	Ω
R <sub>DS(ON)</sub>	Static Drain-Source ON-Resistance <sup>(3)</sup>	V <sub>GS</sub> = 4.5V, I <sub>D</sub> = 0.2A	-	2.0	2.4	Ω
Dynamic	Characteristics					
C <sub>iss</sub>	Input Capacitance		-	28	-	pF
C <sub>oss</sub>	Output Capacitance	V <sub>GS</sub> = 0V, V <sub>DS</sub> = 25V, f = 1MHz	X-\	11	-	pF
C <sub>rss</sub>	Reverse Transfer Capacitance	1 – 110112		4	-	pF
Q <sub>g</sub>	Total Gate Charge	0	<u> </u>	1.7	-	nC
$Q_{gs}$	Gate Source Charge	$V_{GS} = 0 \text{ to } 4.5V$ $V_{DS} = 10V, I_{D} = 0.3A$	-	0.3	-	nC
$Q_gd$	Gate Drain("Miller") Charge	$v_{\rm DS} = 10v, I_{\rm D} = 0.3A$	-	0.6	-	nC
Switchin	g Characteristics					
t <sub>d(on)</sub>	Turn-On DelayTime		-	2	-	ns
t <sub>r</sub>	Turn-On Rise Time	V <sub>GS</sub> = 10V, V <sub>DD</sub> = 10V	-	15	-	ns
$t_{d(off)}$	Turn-Off DelayTime	$I_D$ = 0.2A, $R_{GEN}$ = 10 $\Omega$	-	7	-	ns
t <sub>f</sub>	Turn-Off Fall Time		-	20	-	ns
Drain-So	urce Diode Characteristics and I	Max Ratings				
I <sub>S</sub>	Maximum Continuous Drain to Source D	iode Forward Current	-	-	0.3	А
I <sub>SM</sub>	Maximum Pulsed Drain to Source Diode	Forward Current	-	-	1.2	А
$V_{SD}$	Drain to Source Diode Forward Voltage	V <sub>GS</sub> = 0V, I <sub>S</sub> = 0.3A	-	-	1.2	V
Notes:	1. Repetitive Rating: Pulse Width Limited by Maxir	num Junction Temperature.				

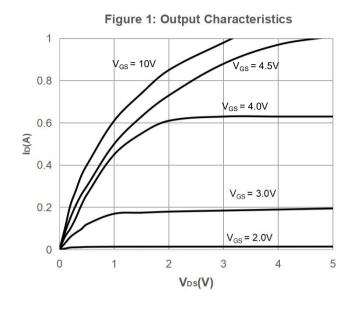
2. R<sub>8JA</sub> is measured with the device mounted on a 1inch<sup>2</sup> pad of 2oz copper FR4 PCB

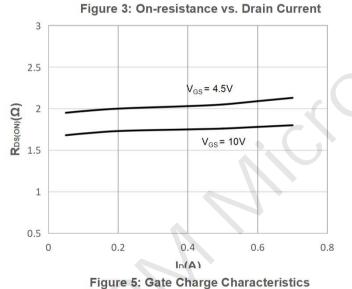
3. Pulse Test: Pulse Width≪300µs, Duty Cycle≪0.5%.

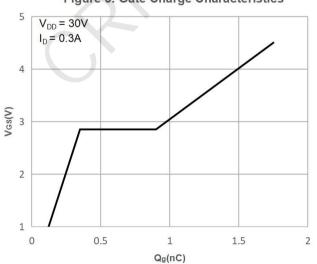


# CRMLCTL2N7002K N-Channel 60V, 1.7Ω Typ. Power MOSFET

# **Typical Performance Characteristics**

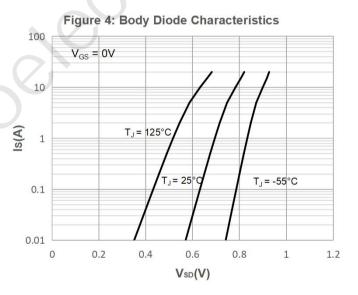


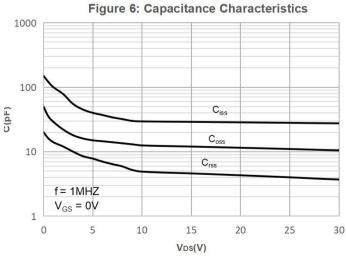




1  $V_{DS} = 5V$ 0.8 25°C 0.6 ID(A) 0.4 0.2 T<sub>J</sub> = 125°C -55°C 0 0 0.5 1.5 2 2.5 3 3.5 4 4.5 5 5.5 6 1 Vgs(V)

**Figure 2: Typical Transfer Characteristics** 

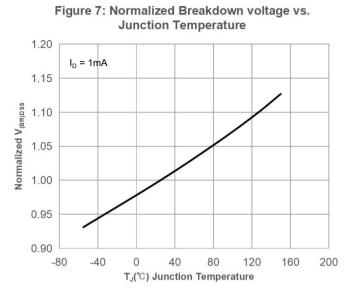




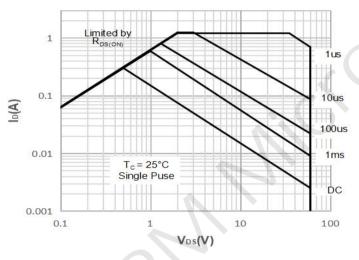


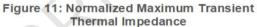
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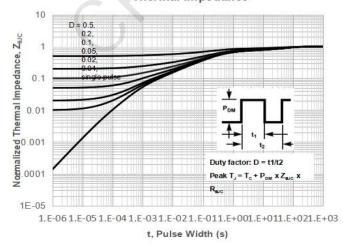
# **Typical Performance Characteristics**

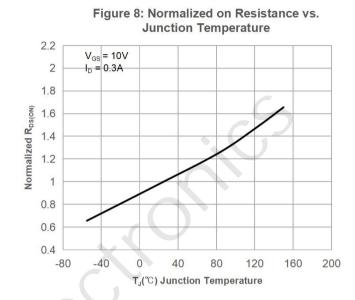


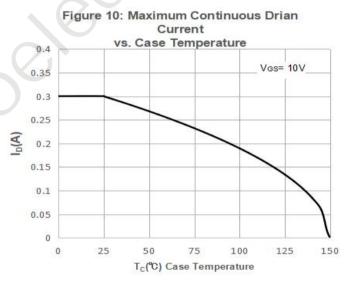
#### Figure 9: Maximum Safe Operating Area



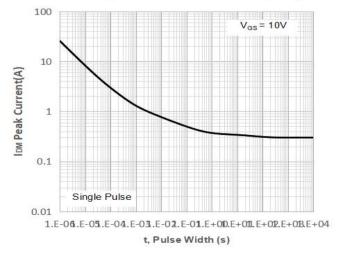








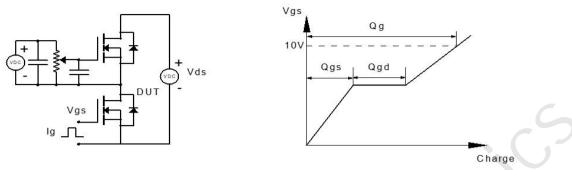
#### Figure 12: Peak Current Capacity





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## **Test Circuit**





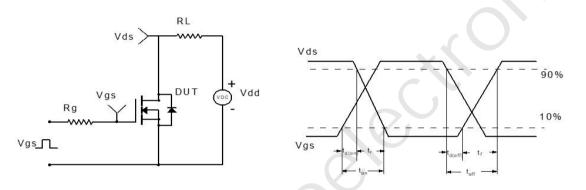
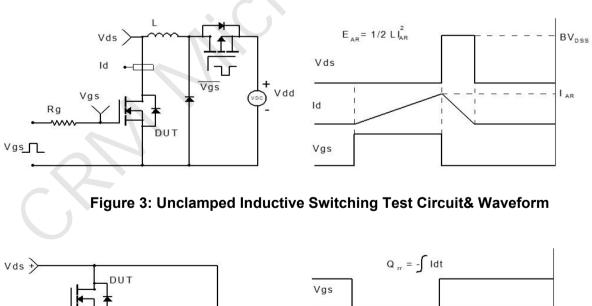


Figure 2: Resistive Switching Test Circuit & Waveform



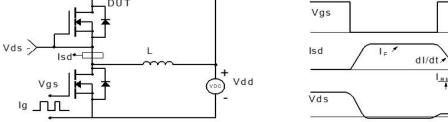


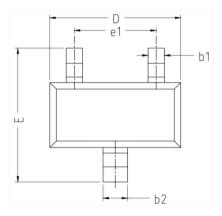
Figure 4: Diode Recovery Test Circuit & Waveform

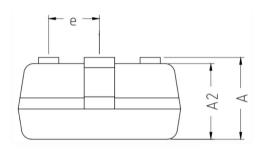
Vdd



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## Package Mechanical Data(SOT-523-3L)





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(	OMMON IN DIMENSIO	IN (MM)		
PKG	S0T-523-3L			
Symbol	MIN	NOM	MAX	
Α	0.700	0.800	0.900	
A2	0.700	0.750	0.800	
b1	0.150	0.200	0.250	
b2	0.250	0.300	0.350	
С	0.100	0.130	0.200	
D	1.550	1.600	1.700	
E	1.450	1.600	1.750	
E1	0.700	0.800	0.900	
e		0.500 TYP		
e1	0.900	1.000	1.100	
L	0.260	0.360	0.460	
L1	0.400REF			
Q	0°	4°	8°	

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